

# Multicore Solder Paste

## Product Images

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## Description

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- Outstanding humidity resistance
- Superior slump resistance
- Colourless, soft, non-stick, pin-testable residue
- Optimised paste viscosity
- Extended open time and tack life
- Halide-free flux classification
- High tack force
- Long printer abandon times
- Excellent solderability
- Wide printing and reflow process windows

